



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary(Typ. @ V_{GS} = -4.5V, T_A = +25°C)

_					
	V _{DSS}	R _{DS(on)}	Qg	Q_{gd}	ID
	-20V	55mΩ	2.9nC	0.5nC	-3.5A

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(on)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- **Battery Management**
- Load Switch
- **Battery Protection**

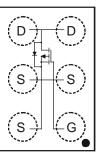
Features and Benefits

- LD-MOS Technology with the Lowest Figure of Merit: $R_{DS(on)} = 55m\Omega$ to Minimize On-State Losses Q_g = 2.9nC for Ultra-Fast Switching
- Vgs(th) = -0.6V typ. for a Low Turn-On Potential
- CSP with Footprint 1.5mm x 1.0mm
- Height = 0.62mm for Low Profile
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: U-WLB1510-6
- Terminal Connections: See Diagram Below
- Weight: 0.0018 grams (Approximate)

U-WLB1510-6



Top View

Ordering Information (Note 4)

	Part Number	Case	Packaging					
	DMP2070UCB6-7	3,000/Tape & Reel						
Notes:	. 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.							

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

U-WLB1510-6



2W = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011)M = Month (ex: 9 = September)

Date	Code	Kev
Daic	oouc	1100

Date Code Rey												
Year	201	1	2012		2013	20	14	2015		2016	2	2017
Code	Y		Z		А	E	3	С		D		E
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Drain-Source Voltage		V _{DSS}	-20	V	
Gate-Source Voltage			V _{GSS}	±8	V
Continuous Drain Current (Note 4) V_{GS} = -4.5V	Steady State	T _A = +25°C T _A = +70°C	ID	-2.5 -2.0	А
Continuous Drain Current (Note 5) V_{GS} = -4.5V	ID	-3.5 -2.8	A		
Pulsed Drain Current (Note 6)		I _{DM}	-12	A	
Maximum Continuous Body Diode Forward Current	t (Note 5)	ls	-1.8	А	

Thermal Characteristics (@T_A = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 4)	PD	0.92	W
Total Power Dissipation (Note 5)	PD	1.47	W
Thermal Resistance, Junction to Ambient (Note 4)	R ₀ JA	136	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	84	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C unless otherwise specified.)

		1	1		1		
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-20	-	-	V	$V_{GS} = 0V, I_D = -250 \mu A$	
Zero Gate Voltage Drain Current $@T_C = +25^{\circ}C$	C I _{DSS}	-	-	-1	μA	$V_{DS} = -16V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(th)}	-0.4	-0.6	-1.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
			55	70		V _{GS} = -4.5V, I _D = - 1A	
Static Drain-Source On-Resistance		-	70	90	mΩ	V _{GS} = -2.5V, I _D = -1A	
Static Drain-Source On-Resistance	R _{DS} (ON)		90	110	11122	$V_{GS} = -1.8V, I_D = -1A$	
			110	150		V _{GS} = -1.5V, I _D = -1A	
Forward Transfer Admittance	Y _{fs}	-	12	-	S	$V_{DS} = -10V, I_{D} = -1A$	
Diode Forward Voltage (Note 5)	V _{SD}	-	-0.7	-1	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 8)						• •	
Input Capacitance	C _{iss}	-	210	-	pF		
Output Capacitance	Coss	-	92	-	pF	V _{DS} = -10V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	-	38	-	pF		
Series Gate Resistance	R _G		5.3	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (4.5V)	Qq	-	2.9	-	nC		
Gate-Source Charge	Q _{gs}	-	0.3	-	nC	$V_{GS} = -4.5V, V_{DS} = -10V,$	
Gate-Drain Charge	Q _{qd}	-	0.5	-	nC	– I _D = -1A ,	
Turn-On Delay Time	t _{D(on)}	-	7.3	-	ns		
Turn-On Rise Time	tr	-	14.0	-	ns	V _{DD} = -10V, V _{GS} = -4.5V,	
Turn-Off Delay Time	t _{D(off)}	-	42.6	-	ns	$I_{DS} = -1A, R_G = 20\Omega,$	
Turn-Off Fall Time	tf	-	32	-	ns	1	

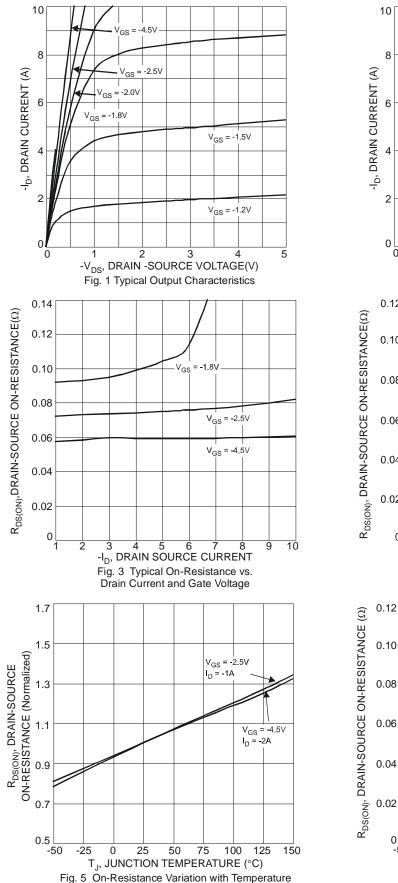
Notes:

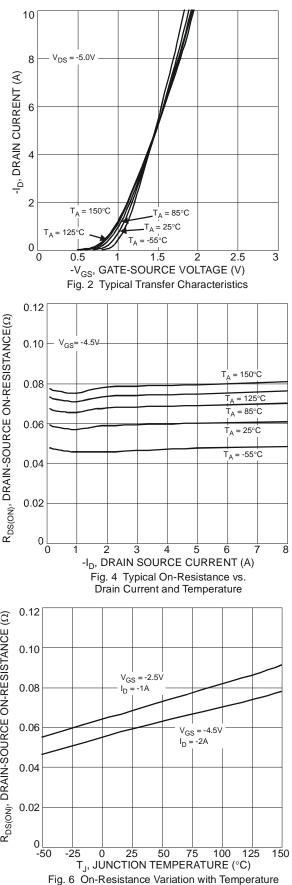
4. Device mounted on FR-4 PCB with minimum recommended pad layout.
5. Device mounted on FR4 material with 1-inch² (6.45-cm²), 2-oz. (0.071-mm thick) Cu.
6 300ms pulse, pulse duty cycle ≤ 2%.
7. Short duration pulse test used to minimize self-heating effect.
9. Oversethed b devices Network is the network of the device of the self.

8. Guaranteed by design. Not subject to production testing.



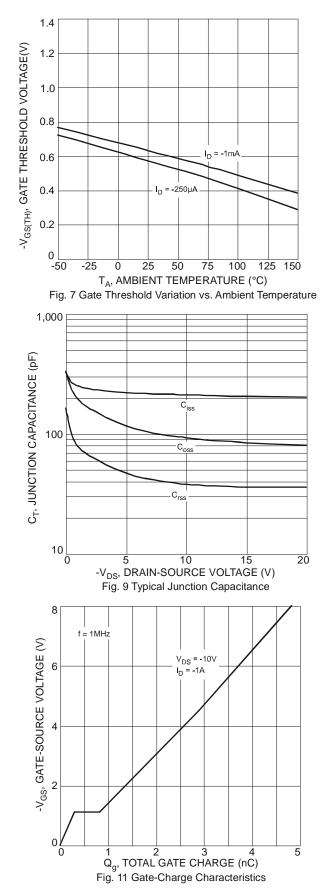
DMP2070UCB6

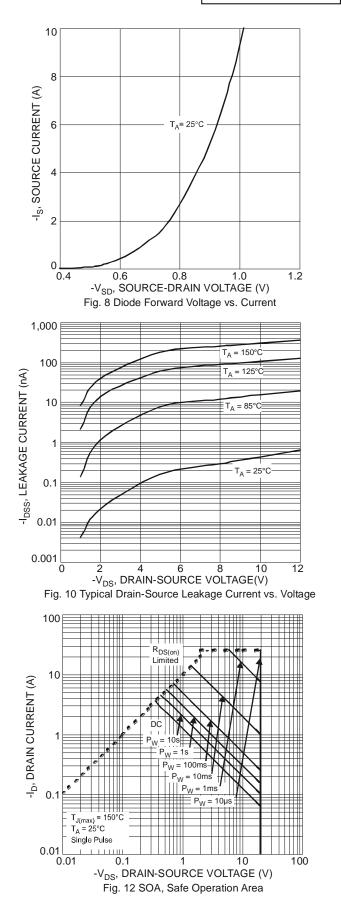




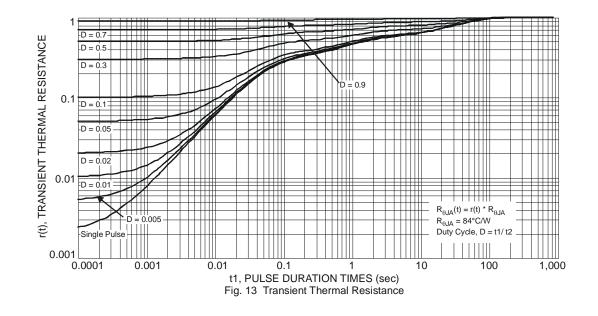


DMP2070UCB6



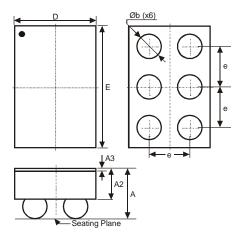






Package Outline Dimensions

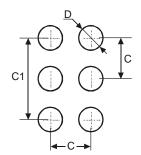
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



U-WLB1510-6								
Dim	Min	Max	Тур					
D	0.90	1.00	1.00					
E	1.40	1.50	1.50					
Α	-	0.62	-					
A2	-	-	0.38					
A3	0.020	0.030	0.025					
b 0.27 0.37 0.32								
e	-	-	0.50					
All	Dimens	ions in r	nm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.50
C1	1.00
D	0.25



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